

IN THE CLAIMS

Please amend the claims as follows:

Claim 1 (Currently Amended): A semiconductor integrated circuit comprising:

a memory;

an ECC circuit that has an error correction function of  $N$  ( $N$  is a natural number) bits for output data of the memory; [[and]]

an error detection circuit configured to output a signal indicative of the following fact, if a total of an error bit number  $n1$  detected by the ECC circuit when a first data pattern in testing target addresses of the memory is read out and an error bit number  $n2$  detected by the ECC circuit when a second data pattern that is an inversion of the first data pattern in at least a part of the testing target addresses is read out exceeds  $N$ ; and

a BIST circuit configured to read the first data pattern out of the testing target addresses of the memory as a first operation,

write the second pattern in at least a part of the testing target addresses as a second operation, and

read out the written second data pattern,

wherein the first data pattern has been corrected by the ECC circuit and is input to the BIST circuit.

Claim 2 (Cancelled).

Claim 3 (Currently Amended) The semiconductor integrated circuit according to claim [[2]] 1,

wherein the BIST circuit repeats the first and second operations while changing the testing target addresses.

Claim 4 (Original): The semiconductor integrated circuit according to claim 3, wherein the BIST circuit writes the first data pattern as background data in all the addresses of the memory before the first and second operations are repeated.

Claim 5 (Currently Amended): The semiconductor integrated circuit according to claim [[2]] 1, wherein:

the ECC circuit outputs SEC signals indicative of the error bit numbers  $n1$  and  $n2$ ;  
the BIST circuit outputs a first reading signal during reading of the first data pattern, and a second reading signal during reading of the second data pattern; and  
the error detection circuit stores the error bit number  $n1$  upon reception of the first reading signal, and the error bit number  $n2$  upon reception of the second reading signal, and calculates  $n1+n2$  by logic processing.

Claim 6 (Original): The semiconductor integrated circuit according to claim 5, wherein the error bit numbers  $n1$  and  $n2$  are stored in registers.

Claim 7 (Original): The semiconductor integrated circuit according to claim 1, wherein the error detection circuit sets only a bit among bits of the testing target addresses in which the second data pattern has been written to be checked, and counts in the error bit number  $n2$  for an error generated in the bit to be checked.

Claim 8 (Original) The semiconductor integrated circuit according to claim 7, wherein the testing target addresses contain data bits and code bits, and bits other than the bit to be checked are parts of the data bits.

Claim 9 (Original): The semiconductor integrated circuit according to claim 7,  
wherein the testing target addresses contain data bits and code bits, and bits other than  
the bit to be checked are parts of the code bits.

Claim 10 (Original): The semiconductor integrated circuit according to claim 7,  
wherein:  
the ECC circuit outputs an SEC signal indicative of presence of an error to each of the  
bits of the testing target addresses;  
the BIST circuit outputs a state signal indicative of the first and second test patterns;  
and  
the error detection circuit specifies the bit to be checked based on the state signal, and  
obtains the error bit number  $n_2$  for the bit to be checked based on the SEC signal.

Claim 11 (Original): The semiconductor integrated circuit according to claim 1,  
wherein the  $N$  is 1.

Claim 12 (Previously Presented): The semiconductor integrated circuit according to  
claim 10, wherein the semiconductor integrated circuit constitutes a part of a system LSI.

Claim 13 (Original): A test method of a semiconductor memory with an ECC circuit  
comprising:  
reading a first data pattern out of testing target addresses of a memory;  
detecting an error bit number  $n_1$  by using the ECC circuit that has an error correction  
function of  $N$  ( $N$  is a natural number) bits;

writing/reading a second data pattern that is an inversion of the first data pattern in at least a part of the testing target addresses;

detecting an error bit number  $n_2$  by using the ECC circuit; and

determining whether a total of the error bit numbers  $n_1$  and  $n_2$  exceeds  $N$  or not.

Claim 14 (Original): The test method according to claim 13,

wherein after the first data pattern is written as background data in all the addresses of the memory, the reading of the first data pattern and the writing/reading of the second data pattern are repeated while the testing target addresses are changed.

Claim 15 (Original): The test method according to claim 13,

wherein the error bit numbers  $n_1$  and  $n_2$  are stored in registers.

Claim 16 (Original): The test method according to claim 13, wherein only a bit among the bits of the testing target addresses in which the second data pattern has been written is set to be checked, and the error bit number  $n_2$  is counted in for an error generated in the bit to be checked.

Claim 17 (Original): The test method according to claim 16, wherein the ECC circuit determines presence of an error for each of the bits of the testing target addresses.

Claim 18 (Original): The test method according to claim 16, wherein the bit to be checked is specified based on the first and second data patterns.

Claim 19 (Original): The test method according to claim 13, wherein the first and second data patterns are generated in a chip.

Claim 20 (Previously Presented): The test method according to claim 13, wherein the semiconductor integrated circuit is determined to be a defective product when a total of the error bit numbers  $n1$  and  $n2$  exceeds  $N$ .